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Document Number: MC33287 Rev. 5.0, 2/2007

Contact Monitoring and Dual Low-Side Protected Driver

The 33287 interfaces between switch contacts and a microcontroller. Eight switch-to-battery (or switch-to-ground) sense monitor switch status. Additionally, two internal low-side switches are available to control inductive or capacitive loads.

The 33287 has eight sense inputs (rated at 40 V) with thresholds ratiometric to V_{BAT} . One sense input has a dedicated output for direct interfacing to the MCU and the remaining seven inputs are multiplexed interfaced to the MCU.

The two low-side switch outputs are current limited to 535 mA and internally clamped to 50 V. Outputs also have independent overtemperature shutdown and diagnostic reporting.

Features

- · Eight High-Voltage Sense Inputs
- · Direct Interfacing to Microcontroller
- · Two Current Limited Low-Side Drivers
- Drivers Internally Overvoltage Clamped and Thermally Protected
- 55 μA Standby Current
- · Pb-Free Packaging Designated by Suffix Code EG

33287

AUTOMOTIVE CONTACT MONITORING AND DUAL LOW-SIDE PROTECTED DRIVER



DW SUFFIX EG SUFFIX (PB-FREE) 98ASB42343B 20-PIN SOICW

ORDERING INFORMATION			
Device	Temperature Range (T _A)	Package	
MC33287DW/R2	-40 to 125°C	20 SOICW	
MCZ33287EG/R2	-40 to 125°C	20 3010W	

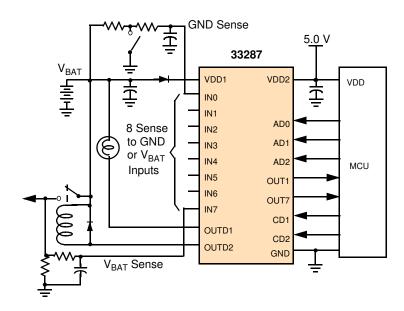


Figure 1. Simplified Application Design





INTERNAL BLOCK DIAGRAM

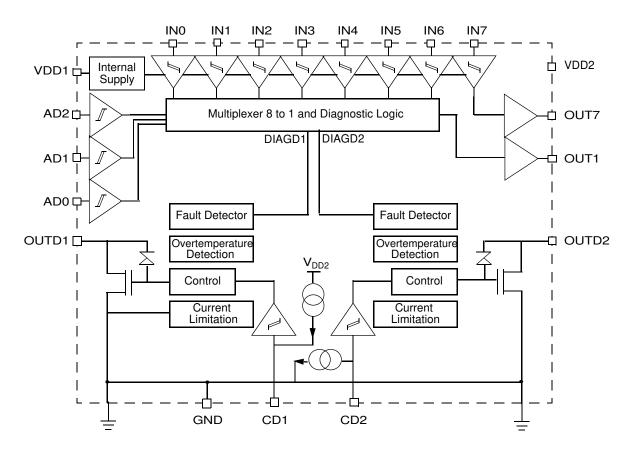


Figure 2. 33287 Simplified Internal Block Diagram



PIN CONNECTIONS

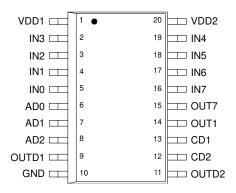


Figure 3. 33287 Pin Connections

Table 1. 33287 Pin Definitions

Pin Number	Pin Name	Formal Name	Definition
1, 20	$V_{DD1,}V_{DD2}$	Voltage Power	These are high-voltage power supply 5.0 V pins (V _{BAT}).
5, 4, 3, 2, 19, 18, 17, 16	INO – IN7	Input 0 – 7	These are high-voltage input pins.
6, 7, 8	AD0 – AD2	Address	These pins are the addresses for mode and input selection.
9, 11	OUTD1, OUTD2	Output Drain	These two are output driver pins (drain).
10	GND	Ground	This pin in the ground for the logic and analog circuitry of the device.
12, 13	CD1, CD2	Command Driver	These are the two driver command pins.
14	OUT1	Output 1	This is the output (multiplexed Output 1 = 0 to 6.0 V for IN0 to IN6 and DIAGD1 or DIAGD2) and DIAGD2 pins.
15	OUT7	Output 7	This is the direct output from IN7 pin.



ELECTRICAL CHARACTERISTICS

MAXIMUM RATINGS

Table 2. MAXIMUM RATINGS

All voltages are with respect to ground unless otherwise noted.

Rating	Symbol	Value	Unit
Power Supply Voltage	V _{DD1}		V
Normal Operation (Steady-State)		24	
Load Dump Conditions		40	
Logic Supply Voltage (Continuous)	V _{DD2}	7.0	V
Input Pin Voltage (1)	V _{IN}	40	V
ESD Voltage (2)			V
Human Body Model	V _{ESD1}	±2000	
Machine Model	V _{ESD2}	±200	
Operating Ambient Temperature	T _A	-40 to 125°C	°C
Storage Temperature	T _{STG}	-65 to 150	°C
Power Dissipation (T _A = 85°C)	P _D	0.7	W
Peak Package Reflow Temperature During Reflow (3), (4)	T _{PPRT}	Note 4.	°C
Thermal Resistance Junction-to-Ambient	Rθ _{J-A}	100	°C/W

Notes

- 1 With Serial Resistor $\geq 25 \text{ k}\Omega$
- 2 ESD1 testing is performed in accordance with the Human Body Model ($C_{ZAP}=100 \text{ pF}, R_{ZAP}=1500 \Omega$), ESD2 testing is performed in accordance with the Machine Model ($C_{ZAP}=200 \text{ pF}, R_{ZAP}=0 \Omega$).
- 3. Pin soldering temperature limit is for 10 seconds maximum duration. Not designed for immersion soldering. Exceeding these limits may cause malfunction or permanent damage to the device.
- 4. Freescale's Package Reflow capability meets Pb-free requirements for JEDEC standard J-STD-020C. For Peak Package Reflow Temperature and Moisture Sensitivity Levels (MSL), Go to www.freescale.com, search by part number [e.g. remove prefixes/suffixes and enter the core ID to view all orderable parts. (i.e. MC33xxxD enter 33xxx), and review parametrics.



STATIC ELECTRICAL CHARACTERISTICS

Table 3. STATIC ELECTRICAL CHARACTERISTICS

Characteristics noted under conditions 7.0 V \leq V_{DD1} \leq 18 V, 4.75 V \leq V_{DD2} \leq 5.25 V, -40°C \leq T_A \leq 125°C, unless otherwise noted. Extended limit is 5.0 V \leq V_{DD1} \leq 7.0 V and other parameters are full specification in this mode. Inputs IN1–IN7 and low-side drivers are still functional with down-graded characteristics.

side drivers are still functional with down-graded characteristics.		 		T .	
Characteristic	Symbol	Min	Тур	Max	Unit
SUPPLY VOLTAGE (V _{DD1} AND V _{DD2} PINS)					
Operational Supply Voltage	VDD1				V
Full Specification		7.0	12	18	
Extend Limit		5.0	_	7.0	
Operational Supply Voltage (Full Specification)	VDD2	4.75	_	_	٧
Supply Current Standby Mode ⁽⁵⁾					μΑ
$V_{DD1} \le 14 \text{ V}$	IVDD1-0	_	55	110	
$V_{CD1} = V_{DD2}$, $V_{CD2} = 0 V$	I _{VDD2-0}	_	_	10	
Supply Current in Drivers on Configuration (Full Specification) ⁽⁵⁾					μΑ
$V_{CD1} = 0 V$	IVDD1-1	_	250	1500	
$V_{CD2} = V_{DD2}$	I _{VDD2-1}	_	650	1500	
OUTPUT DRIVERS CHARACTERISTICS (OUTD1 AND OUTD2 PINS)		1		1	
Output Resistance (Full Specification and $T_J \le 130^{\circ}\text{C}$)	R _{DS(ON)}	_	1.40	3.20	Ω
Output Resistance (Extent Limit and $T_J \le 130^{\circ}C$)	R _{DS(ON)}	_	_	5.0	Ω
Leakage Current (Internal Current Source)	I _{LEAK}	1.0	_	13	μs
PROTECTION AND LEVEL DETECTION (OUTD1 AND OUTD2 PINS)					
Positive Output Clamp	V_{CLAMP}	40	50	60	V
Output Current Limitation (130°C \geq T _J)	I _{LIM}	300	535	750	mA
Output Fault Detector Level	V _{FAULT}	2.0	2.75	3.5	V
Overtemperature Detection (at 25°C by Function Simulation)	T_{DETEC}	145	160	175	ŷ
NPUTS (CD1 AND CD2 PINS)					
Input Voltage Low	V_{IL}	_	_	4.0 x V _{DD2}	V
Input Voltage High	V _{IH}	8.0 x V _{DD2}	_	_	V
Hysteresis	V _{HST}	500	800	_	m۷
Input Current on Pin CD1 (Internal Pull-Up and CD1 Connected to Ground)	I _{CD1}	-100	-30	-10	μΑ
Leakage Current on Pin CD1 (Internal Pull-Up Connected to V _{DD2})	I _{LEAK}	-5.0	_	5.0	μΑ
Input Current on Pin CD2 (Internal Pull Down CD2 Connected to V_{DD2})	I _{CD2}	10	30	100	μΑ
Leakage Current on Pin CD2 (Internal Pull-Up CD1 Connected to Ground)	I _{LEAK}	-5.0	_	5.0	μΑ

Notes

5 All INn and ADn inputs are connected to ground.



Table 3. STATIC ELECTRICAL CHARACTERISTICS (continued)

Characteristics noted under conditions 7.0 V \leq V_{DD1} \leq 18 V, 4.75 V \leq V_{DD2} \leq 5.25 V, -40°C \leq T_A \leq 125°C, unless otherwise noted. Extended limit is 5.0 V \leq V_{DD1} \leq 7.0 V and other parameters are full specification in this mode. Inputs IN1–IN7 and low-side drivers are still functional with down-graded characteristics.

Characteristic	Symbol	Min	Тур	Max	Unit
INPUTS (IN0 TO IN7 PINS)	l .			<u> </u>	
Input Voltage Low (Full Specification)	V _{IL}	_	_	4.0 x V _{DD1}	V
Input Voltage Low (Extended Limit)	V _{IL}	_	_	3.0 x V _{DD1}	V
Input Voltage High (Full Specification and Extended Limit)	V _{IH}	7.0 x V _{DD1}	_	_	V
Hysteresis (5.0 V < V _{DD1} < 16 V)	V _{HYS}	5.0	1.0	_	V
Input Current (V _{IN} < 16 V)	I _{LEAK}	5.0	_	5.0	μΑ
Input Voltage Clamp (I = 100 μA)	V _{INCLAMP}	17	20	23	V
INPUTS (AD0, AD1, AND AD2 PINS)	•				
Input Voltage Low	V _{IL}	_	_	4.0 x V _{DD2}	V
Input Voltage High	V _{IH}	8.0 x V _{DD2}	_	_	V
Hysteresis	V _{HYS}	500	750	_	mV
Input Current	I _{LEAK}	-5.0	_	5.0	μΑ
OUTPUTS (OUT1 AND OUT7 PINS)					
Output Voltage Low (I _{LOAD} = 2.0 mA)	V _{OL}	_	_	2.0 x V _{DD2}	V
Output Voltage High (I _{LOAD} = -2.0 mA)	V _{OH}	8.0 x V _{DD2}	_	_	V



DYNAMIC ELECTRICAL CHARACTERISTICS

Table 4. DYNAMIC ELECTRICAL CHARACTERISTICS

Characteristics noted under conditions 4.5 V \leq V $_{DD}$ \leq 5.5 V, 9.0 V \leq V $_{PWR}$ \leq 16 V, -40°C \leq T $_{A}$ \leq 125°C, unless otherwise noted. Typical values noted reflect the approximate parameter mean at T $_{A}$ = 25°C under nominal conditions, unless otherwise noted.

71 11 1 A					
Characteristic	Symbol	Min	Тур	Max	Unit
OUTPUT DRIVERS CHARACTERISTICS (OUTD1 AND OUTD2 PINS)					
Turn ON Delay Time	t _{ON}	_	1.3	10	μs
Turn OFF Delay Time	t _{OFF}	_	2.1	10	μs
Output Rising Edge	t _{RISE}	_	2.8	10	μs
Output Falling Edge	t _{FALL}	_	1.0	10	μs
Difference Between Command Duration and Bit Duration	Δ_{BIT}	-5.0	_	5.0	μs



TIMING DIAGRAMS

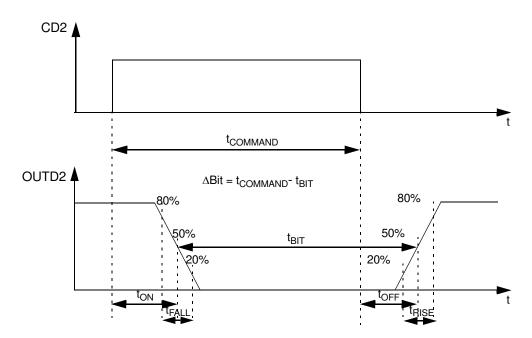


Figure 4. Timing Characteristics

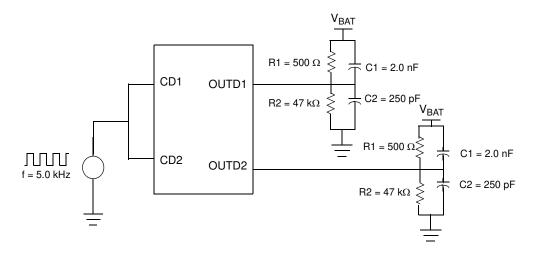


Figure 5. Timing Test Configuration



FUNCTIONAL DEVICE OPERATION

LOGIC COMMANDS AND REGISTERS

Table 5. Drivers Function Table

CD1 ⁽⁶⁾	OUTD1	DIAGD1 ⁽⁸⁾	Status
High Level for Logic Signals	High Level for Drivers Outputs	High Level for Logic Signals	Driver 1 Normally OFF
Low Level for Logic Signals	Low Level for Drivers Outputs	High Level for Logic Signals	Driver 1 Normally ON
High Level for Logic Signals	Low Level for Drivers Outputs	Low Level for Logic Signals	Driver 1 Shorted to GND or Open Load
Low Level for Logic Signals	High Level for Drivers Outputs	Low Level for Logic Signals	Driver 1 Overloaded
CD2 ⁽⁷⁾	OUTD2	DIAGD2	Ctatus
ODL	00102	DIAGD2	Status
Low Level for Logic Signals	High Level for Drivers Outputs	High Level for Logic Signals	Driver 2 Normally OFF
	55122		
Low Level for Logic Signals	High Level for Drivers Outputs	High Level for Logic Signals	Driver 2 Normally OFF

Notes

- 6 CD1 is active on low level (driver 1 is on when CD1 is low).
- 7 CD2 is active on high level (driver 2 is on when CD2 is high.
- 8 DIAGD1 output is neither latched nor filtered.

Table 6. Eight-to-One Data Multiplexer Function

	Inputs				
AD2	AD2 AD1		OUT1		
High Impedance	High Impedance	High Impedance	Unknown		
Low Level	Low Level	Low Level	IN0 ⁽⁹⁾		
Low Level	Low Level	High Level	IN1		
Low Level	High Level	Low Level	IN2		
Low Level	High Level	High Level	IN3		
High Level	Low Level	Low Level	IN4		
High Level	Low Level	High Level	IN5		
High Level	High Level	Low Level	IN6		
High Level	High Level	High Level	DIAGD1 or DIAGD2 ⁽¹⁰⁾		

Notes

- 9 IN0 to IN6 are the normalized values.
- 10 DIAGD1 or DIAGD2 are the values of the selected internal fault detector. See **Table 7**.



Table 7. Fault Detector Selection

	Inputs			
AD2	AD1	AD0	OUT1	
Unknown	Unknown	Unknown	Unknown	
Unknown	Low Level	High Level	Unknown	
High Level	High Level	High Level	DIAGD1	
Unknown	Unknown	Unknown	Unknown	
Unknown	High Level	Low Level	Unknown	
High Level	High Level	High Level	DIAGD2	



TYPICAL APPLICATIONS

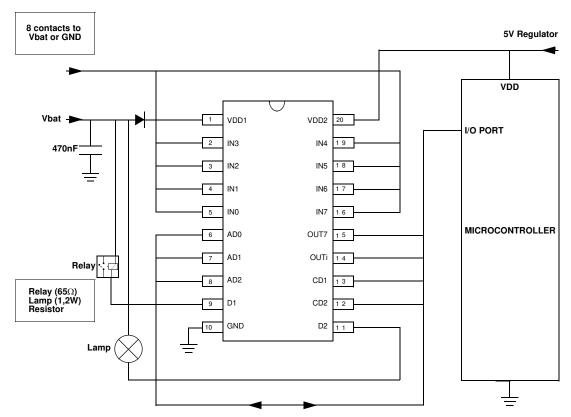


Figure 6. Typical Application Configuration

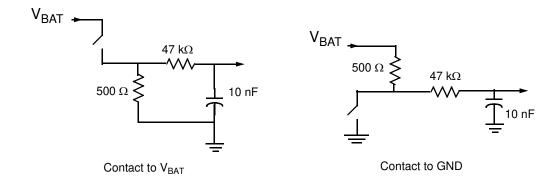
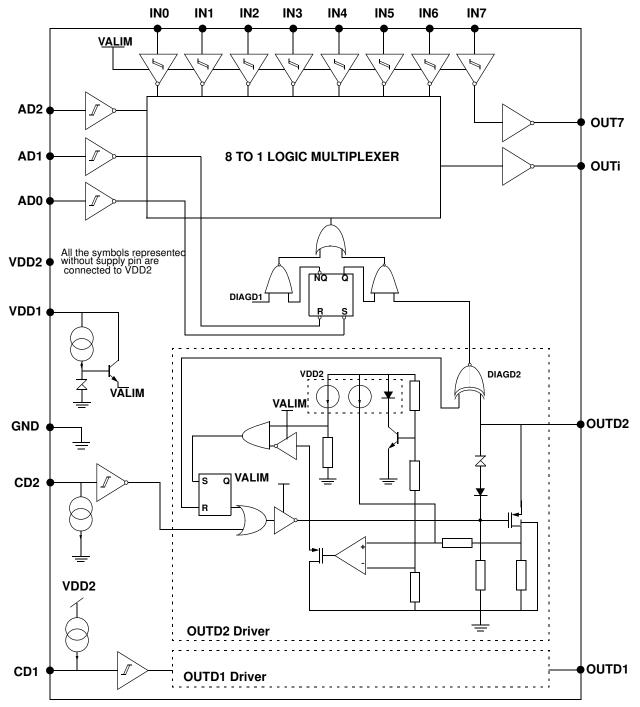


Figure 7. Contact Configuration



NOTE: The only difference between the low side driver 1 and 2 is the polarity of the command. Also, there is an integral pull-up at pin CD1, and an internal pull-down at pin CD2.

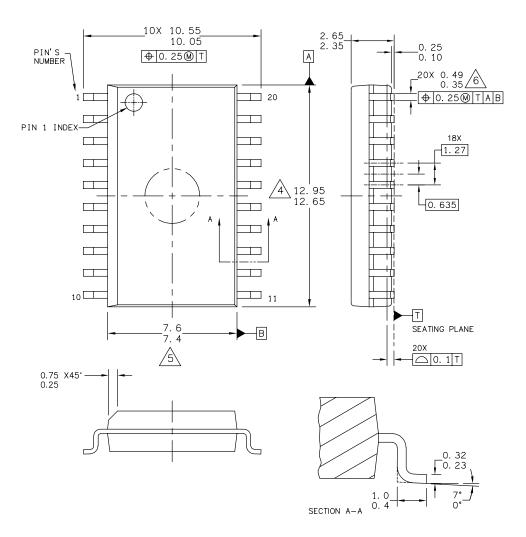
Figure 8. Electrical Schematic



PACKAGE

PACKAGE DIMENSIONS

For the most current package revision, visit <u>www.freescale.com</u> and perform a keyword search using the "98A" listed below.



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TITLE:		DOCUMENT NO): 98ASB42343B	REV: J
20LD SOIC W/B, 1. CASE—OUTLI		CASE NUMBER	R: 751D-07	23 MAR 2005
CASE-001E1	INL	STANDARD: JE	IDEC MS-013AC	

DW SUFFIX EG SUFFIX (PB-FREE) 20-PIN PLASTIC PACKAGE 98ASB42343B REV. J



REVISION HISTORY

REVISION	DATE	DESCRIPTION OF CHANGES
4.0	11/2006	 Converted to Freescale format with the current form and style Implemented Revision History page Updated Package Drawing 98ASB42343B to Rev. J Added EG Pb-FREE suffix Removed Peak Package Reflow Temperature During Reflow (solder reflow) parameter from Maximum Ratings on page 4. Added note with instructions to obtain this information from www.freescale.com.
5.0	2/2007	 Corrected Internal Block Diagram on page 2 Restated Definition for OUT1 in 33287 Pin Definitions on page 3 Corrected value for Storage Temperature on page 4 Corrected unit for Output Resistance (Extent Limit and T_J ≤ 130°C) on page 5 Corrected Electrical Schematic on page 12 Restated note 4 in Maximum Ratings on page 4.



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